

## 2N5905 LOW NOISE, LOW DRIFT MONOLITHIC DUAL N-CHANNEL JFET



The 2N5905 is a high-performance monolithic dual JFET featuring tight matching and low drift over temperature specifications, and is targeted for use in a wide range of precision instrumentation applications where tight tracking is required.

The hermetically sealed TO-78 package is well suited for hi-reliability and harsh environment applications.

(See Packaging Information).

## 2N5905 Benefits:

- Tight Tracking
- Good matching
- Ultra Low Leakage
- Low Drift

	FEATURES						
	LOW DRIFT		$ V_{GS1-2}/T  = 5\mu V/^{\circ}C$ TYP.				
	ULTRA LOW LEAKA	I <sub>G</sub> = 150fA TYP.					
	LOW PINCHOFF		$V_p = 2V TYP.$				
	ABSOLUTE MAXIMUM RATINGS						
@ 25°C (unless otherwise noted)							
	Maximum Temper						
	Storage Temperature				-65°C to +150°C		
	Operating Junction Temperature				+150°C		
Maximum Voltage and Current for Each Transistor – N							
	-V <sub>GSS</sub> Gate Voltage to Drain or Source			40V			
	-V <sub>DSO</sub> Draii	Drain to Source Voltage			40V		
	-I <sub>G(f)</sub> Gate	Gate Forward Current			10mA		
		Gate Reverse Current			10μΑ		
	Maximum Power I		>				
Device Dissipation @ Free Air – Total 40mW @ +125°C						s°C	È
	MATCHING CHARACTERISTICS @ 25°C UNLESS OTHERWISE NOTED						d
	SYMBOL	CHARACTERISTICS	VALUE	UN	ITS	CONDITIONS	5
	V <sub>GS1-2</sub> / T  max.	DRIFT VS.	40	μV/°C		$V_{DG}$ =10V, $I_{D}$ =30 $\mu$ A	Ū
		TEMPERATURE				T <sub>A</sub> =-55°C to +125°C	5
	V <sub>GS1-2</sub>   max.	OFFSET VOLTAGE	15	mV		$V_{DG}$ =10V, $I_{D}$ =30 $\mu$ A	ä
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ELECTRICAL CHARACTERISTICS @ 25°C (unless otherwise noted) CHARACTERISTICS UNITS CONDITIONS SYMBOL MIN. TYP. MAX Breakdown Voltage 40 60  $BV_{GSS}$ V  $V_{DS} = 0$  $I_D=1nA$ 40  $I_S = 0$ Gate-To-Gate Breakdown V  $BV_{GGO}$ I<sub>G</sub>= 1nA  $I_D = 0$ TRANSCONDUCTANCE **Full Conduction** 300 70 500 μmho  $V_{DG} = 10V$  $V_{GS} = 0V$ f = 1kHz $Y_{fSS}$  $Y_{fS}$ Typical Operation 50 **20**0 μmho  $V_{DG} = 10V$  $I_D = 30 \mu A$ f = 1kHz|Y<sub>FS1-2</sub> / Y<sub>FS</sub> Mismatch 1 % DRAIN CURRENT <sub>DG</sub>= 10V <sub>GS</sub>= 0V Full Conduction 400 1000 μΑ  $I_{DSS}$  $|I_{DSS1-2}/I_{DSS}|$ Mismatch at Full Conduction 2 5 % **GATE VOLTAGE** V<sub>GS</sub>(off) or V<sub>n</sub> Pinchoff voltage 0.6 2 4.5  $V_{DS} = 10V$ I<sub>D</sub>= 1nA V<sub>GS</sub>(on) **Operating Range** 4 V  $V_{DS}=10V$  $I_D=30\mu A$ **GATE CURRENT**  $V_{DG} = 10V I_D = 30\mu A$ Operating 3 -I<sub>G</sub>max. Αg T<sub>A</sub>= +125°C -I<sub>G</sub>max. High Temperature --3 nΑ At Full Conduction \_\_ 5 рΑ  $V_{DS} = 0V$ V<sub>GS</sub>= 20V -I<sub>GSS</sub>max. High Temperature --10 nΑ T<sub>A</sub>= +125°C -I<sub>GSS</sub>max. 1 Gate-to-Gate Leakage рΑ V<sub>GG</sub>= 20V  $I_{GGO}$ **OUTPUT CONDUCTANCE Full Conduction** 5  $V_{DG} = 10V$  $V_{GS} = 0V$ Yos Operating 0.1 0.1 μmho  $V_{DG} = 10V$  $I_D = 30 \mu A$  $|Y_{OS1-2}|$ Differential 0.01 0.1 **COMMON MODE REJECTION** CMR  $-20 \log |\Delta V_{GS1-2}/\Delta V_{DS}|$ 90 dB  $\Delta V_{DS} = 10 \text{ to } 20V$  $I_D = 30 \mu A$ 90 CMR -20 log  $|\Delta V_{GS1-2}/\Delta V_{DS}|$  $\Delta V_{DS} = 5 \text{ to } 10V$  $I_D=30\mu A$ 

C<sub>DD</sub> Drain-to-Drain -
Note 1 – These ratings are limiting values above which the serviceability of any semiconductor may be impaired

**NOISE** 

**Figure** 

Voltage

**CAPACITANCE** 

Input

Reverse Transfer

Available Packages:

NF

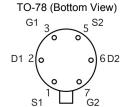
 $e_n$ 

 $C_{ISS}$ 

 $C_{RSS}$ 

2N5905 in TO-78 2N5905 available as bare die

Please contact  $\underline{\text{Micross}}$  for full package and die dimensions



70

3

1.5

0.1

dB

nV/√Hz

рF

Micross Components Europe

 $V_{DS} = 10V$ 



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 $V_{DS} = 10V$   $V_{GS} = 0V$ 

 $V_{DG}$ =10V  $I_D$ =30 $\mu$ A f=10Hz NBW=1Hz

 $V_{GS} = 0V$ 

 $V_{DG} = 20V \quad I_D = 30\overline{\mu A}$ 

f= 100Hz

 $R_G = 10M\Omega$ 

f= 1MHz

NBW= 6Hz

20